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Bib Data Sheet

CONFIRMATION NO. 8959

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|-----------------------------|---------------------------------------|--------------|------------------------|---|
| SERIAL NUMBER<br>10/773,592 | FILING DATE<br>02/06/2004<br><br>RULE | CLASS<br>257 | GROUP ART UNIT<br>2815 | ATTORNEY<br>DOCKET NO.<br>021653-000400US |
|-----------------------------|---------------------------------------|--------------|------------------------|---|

APPLICANTS  
  
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\*\* CONTINUING DATA \*\*\*\*\*  
*npk*

\*\* FOREIGN APPLICATIONS \*\*\*\*\*  
CHINA 200310122959.4 12/30/2003 *npk*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED  
\*\* 05/06/2004

|   |                              |                        |                       |                            |
|---|------------------------------|------------------------|-----------------------|----------------------------|
| Foreign Priority claimed<br><input checked="" type="checkbox"/> yes <input type="checkbox"/> no   | STATE OR<br>COUNTRY<br>CHINA | SHEETS<br>DRAWING<br>2 | TOTAL<br>CLAIMS<br>17 | INDEPENDENT<br>CLAIMS<br>2 |
| 35 USC 119 (a-d) conditions met<br><input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance |                              |                        |                       |                            |
| Verified and Acknowledged<br><i>npk</i><br>Examiner's Signature   | <i>npk</i><br>Initials       |                        |                       |                            |

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TITLE  
Method and structure to form capacitor in copper damascene process for integrated circuit devices

|                                   |   |  |
|-----------------------------------|---|--|
| FILING FEE<br><br>RECEIVED<br>770 | FEES: Authority has been given in Paper<br>No. _____ to charge/credit DEPOSIT ACCOUNT<br>No. _____ for following: | <input type="checkbox"/> All Fees<br><input type="checkbox"/> 1.16 Fees ( Filing )<br><input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )<br><input type="checkbox"/> 1.18 Fees ( Issue ) |
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